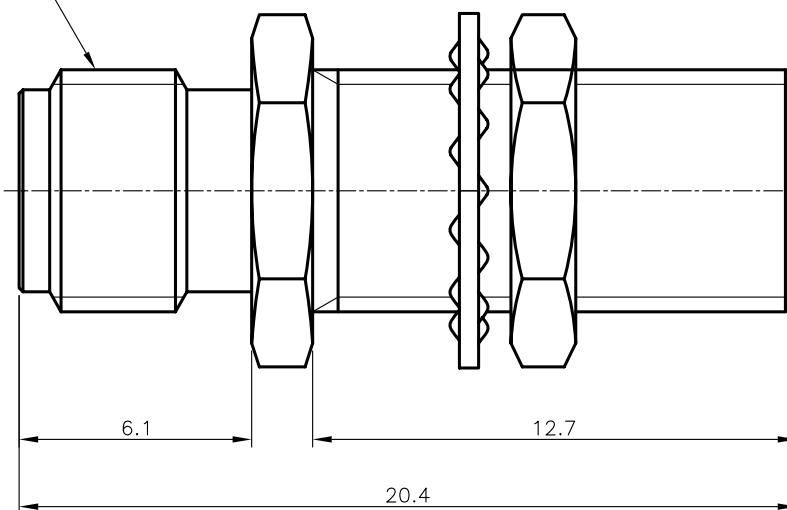
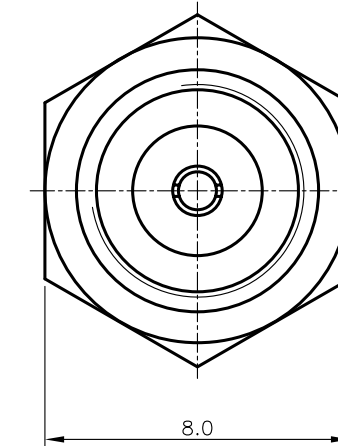


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
1 R	Initial Registration			2004.04.06.
1	[설번No.201003-0017] 조립성 향상(TEF 외경 치수 불량으로 인한 변경)	D.W.KANG	Y.H.CHOI	2010.03.17.
2	[설번No.201303-0012] 신뢰성 향상 (뉘시바늘 추가)	E.H.KIM	I.C.KIM	2013.03.15.

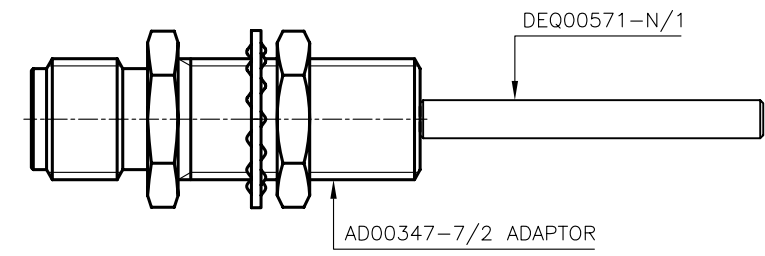
2-1/4 36 UNS-2A



* PATCH ANTENNA 상대물 PIN 외경 치수 : $\varnothing 0.85 - 0.05$



※ 완제품 조립 후 상대물 핀 지그 DEQ00571-N/1(SUS) 사용하여 핀 삽/이탈력 확인 할 것
 - 상대물 핀 지그 실측 외경 : $\varnothing 0.85$
 - 삽/이탈력 : 0.2kgf ~ 1.0kgf 관리



6	WASHER	1	BsS	Gold Plate	DWA00005-5/1
5	NUT	1	MBsBD	Gold Plate	DNT00025-5/1
4	INSULATOR	1	TEFLON	White	DIN00216-N/1
3	INSULATOR	1	TEFLON	White	DIN00093-N/1
2	CONTACT	1	BeCu	Gold Plate	DCT00338-5/1
1	BODY	1	MBsBD	Gold Plate	DBD00416-5/2
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE
DATE 2013. 03. 14.					
TOLERANCE			APPROVED BY I.C.KIM		
MATERIAL			CHECKED BY		
FINISH			DRAWN BY E.H.KIM		
SCALE 5/1			UNIT mm		
DATE 2013. 03. 14.			TITLE SMA50 (F) PATCH (F) ST ADAPTOR		
DWG NO. AD00347-7/2			REVISION 2		
SHEET 1 of 1			SHEET 1 of 1		

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